

PACKAGING HOT MELT**SW5070**

Application: For bonding purposes in packaging processes, e.g. for cartons, trays, and folding boxes, including printed and lacquered surfaces.

Characteristics: A high-performance metallocene adhesive offering excellent bond strength, enhanced cold flexibility, and heat resistance. (Comparable to Technomelt Supra 100 cool)

Specification:

Polymer basis	Polyolefin
Viscosity at 160°C (mPa s)	1,000 - 2,000
Softening point	110 - 115°C
Setting time /25°C	< 5 sec
Supply form	White, translucent melt in granules
Application temperature	150 - 170°C

Packaging & Storage: in 25 kg kraft bag. 40 bags/ pallet
Shelf life of 24 months, in original package, cool and dry (15-35°C).

Remarks: All data indicated are characteristics represented as average values. Our technical data sheets are revised to represent the latest information. This edition is valid on the date of compilation.

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